3.4 Thin Films: Structure, Interfaces and Some Properties

Let's look at a perfect epitaxial interface between **A** and **B** in a simple picture:

3.4.1 Single Crystalline Thin Films

Epitaxial Growth

In semiconductor technology we make all kinds of thin films. Often, we make thin films of some semiconducting material (cf. <u>this picture</u>) and then we want this thin film to be a perfect single crystal with no defects whatsoever (except what we intentionally put in, e.g. for doping).

- This is a tough job description. How can you make a single crystalline thin film? Think about it. If you do it on a Si substrate wafer with 300 mm diameter, you are actually demanding that any atom of your material B sitting somewhere on your substrate, has a precise geometrical relation to any other atom being many centimeters away, for example.
- You may think as hard and as long as you like, but the only way to do this is to deposit your thin film on a single crystalline substrate to start with. If you are lucky, your B-atoms then just continue the lattice of the A-substrate and you have epitaxial growth or epitaxy for short. The term "epitaxy" comes from the Greek "epi" meaning "above", and "taxis" meaning "in ordered manner".

That's what you want - but that is not what you will get. The reason is that we must assume that the two lattice constants *a* of **A** and **B** are *not* identical as shown on the right; we are lucky if the Bravais lattice types are.

- In fact, it you look at our old "<u>master picture</u>", summarizing the basic properties of important semiconductors, you see that the lattice constants of those semiconductors are mostly quite different.
- That leaves us with just two options:
 - 1. We may have a perfect epitaxial situation as shown above, but then we also have a lot of strain ϵ and stress σ in our layer **B**, because we must squeeze it to fit on the substrate. The strain energy stored in the stressed layer necessarily scales with $\epsilon \cdot \sigma$ and the thickness d_z of the layer. Stress and strain scale with the **misfit** $f = (a_A a_B)/a_A$ of the situation, i.e. the relative difference of the lattice constants.
 - 2. We will not have a perfect epitaxial interface.

It's as simple as that. The question now is how much strain energy can a thin film take before it is going to do a little stress relief by one means or another?

- That depends on the means available fro stress relief. The most simple way of obtaining some stress relief is to suffer some plastic deformation, i.e. producing and moving some dislocations around.
- This is exactly what will happen if the stress in a perfectly epitaxial thin film reaches some critical value: the film deforms plastically and introduces what we call **misfit dislocations**. A thin film may even do this if it cannot be plastically deformed as a bulk crystal like, e.g., Si. Misfit dislocations are easy to visualize:



- We have the same situation as above, but now we have misfit dislocations in the interface. They must by necessity be edge dislocations (as indicated by the red lines), or more generally, their <u>Burgers vector</u> must have a sizeable component in the interface.
- Obviously you must have dislocations at regular distances d_{dis} (in at least two directions you will get a network) given by d_{dis} = a_A/f.

Now we have no more strain and strain energy in the thin film, but a lot of dislocations in the interface. We <u>know</u> or just believe that dislocations carry approximately the energy $E_{disl} = Gb^2$ per unit length (G = shear modulus). So what is better?

Same procedure every time. Look at the energy and compare:

- *Perfect interface*: The total strain energy scales with $f \cdot d_z$.
- Interface with misfit dislocations: The energy scales with the total dislocation length or with the dislocation density, and thus only with *f* and not (or just a little bit) with *d*_z.

In other words: There is always some critical thickness d_{crit} of the thin layer so that for $d_z > d_{crit}$ the introduction of *misfit dislocations* in the interface is energetically favorable to having a strained layer.

Going through the energy comparison in detail (not quite as easy as it looks) produces a very important, very sad, and transcendent equation for the critical thickness; it is given below with a simple approximation added.



b is the magnitude of the Burgers vector, v = Poisson's ratio, $e = base of natural logarithms, <math>r_0$ the "size" of the dislocation core (about 1*b*).

Why is this a sad equation? Look at its graph. It shows the numerical solution to the equation from above and the approximate solution.



It also shows, sadly, that the critical thickness is rather small if there is any misfit at all. A misfit of just 1% will lead to an interface full of dislocations if the thin layer thickness exceeds about 4 nm!

It goes without saying, of course, that this is *seriously bad*. If you don't know why, look at what you have <u>learned</u> <u>before</u>. Defects like dislocations are never good news for electrons and holes in semiconductors. They reduce minority carrier diffusion lengths and life times, the efficiency of light generation, and the product life time of Laser diodes, for example.

You just can't have misfit dislocations in your electronically active semiconductor - semiconductor interfaces. *None whatsoever*!

Now we understand why the lattice constant is the second important property besides the band gap and plotted in our <u>master picture</u>, and why there are so many combinations of semiconductors that we don't use.

Being engineers, we now ask ourselves if there are some tricks to beat the critical thickness equation from above. The answer is: Yes - but you don't get very far at present. One of the neater ideas, going under the heading of "<u>compliant</u> <u>substrates</u>", can be accessed by the link.

The picture below shows an extreme case of misfit dislocation for a misfit of about **15** %. We have hexagonal **NiSi** with its **{0001}** plane in line with the **{111}** plane of **Si**. Since both lattice planes are hexagonal in this case, we can have an epitaxial relationship between tow different Bravais lattices.



As we must expect, we have an edge dislocation (seen as ending lattice fringe) about every **7** lattice constants. This is one of the first pictures of misfit dislocations at atomic resolution. The dislocations are so close that they could not be seen in "normal" **TEM**.